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2013297-1 Product Details

Have a Question?

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Memory Sockets

Always EU RoHS/ELV Compliant (Statement of Compliance)

Product Highlights:

- Socket Type = Memory Card Socket Style = SO DIMM
- Gold Flash Contact Plating, Mating Area, Material
- 204 Positions
 DRAM Type = Double Data Rate (DDR) III

View all Features

Quick Links

Check Pricing & Availability Search for Tooling Product Feature Selector Contact Us About This Product

TE Internal Number: 2013297-1











Documentation & Additional Information

Product Drawings:

• DDR3 SODIMM SOCKET 0.6mm PITCH 204POS 8.0mm HEIGHT S... (PDF, Japanese)

Catalog Pages/Data Sheets:

Product Specifications:

Application Specifications:

Instruction Sheets:

CAD Files: (CAD Format & Compression Information) • 2D Drawing (DXF, Version C1) • 3D Model (IGES, Version C1)

- 3D Model (STEP, Version C1)

Additional Information:

Product Line Information

Related Products:

Tooling

Product Features (Please use the Product Drawing for all design activity)

- Product Type Features:

 Socket Style = SO DIMM

 DRAM Type = Double Data Rate (DDR) III
 - PCB Mount Style = Surface Mount
 - Module Orientation = 25°
 - Comment = With floating page.

Mechanical Attachment:

Keving = Standard

Electrical Characteristics:

DRAM Voltage = 1.5 V

Body Related Features:

- · Socket Type = Memory Card
- Number of Positions = 204
- Row-to-Row Spacing (mm [in]) = 8.20 [0.322] Centerline (mm [in]) = 0.60 [0.024]
- Number of Rows = Dual
- Ejector Type = Locking
- Ejector Location = Both Ends
- Number of Keys = 1
- Latch Material = Stainless Steel
- Latch Plating = Tin
- Boss = With

Contact Related Features:

List all Documents

- Contact Plating, Mating Area, Material = Gold Flash
- Contact Base Material = Copper Alloy

- Housing Related Features:

 Housing Material = High Temperature Thermoplastic
 - Housing Color = Black

Configuration Related Features:

- Stack Height (mm [in]) = 8.00 [0.315]
 Insertion Style = Cam-In
- Center Key (mm [in]) = Offset Left

- RoHS/ELV Compliance = RoHS compliant, ELV compliant
- Lead Free Solder Processes = Reflow solder capable to 245°C, Reflow solder capable to 260°C
- RoHS/ELV Compliance History = Always was RoHS compliant

Operation/Application:

Application Type = DDR 3 SO-DIMM

Packaging Related Features:

Packaging Method = Semi-Hard Tray Assembly

Other:

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Email or Chat with Us

• Brand = Tyco Electronics

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